

CAMMASTER+

CAMERA PROCESSOR REFERENCE DESIGN









NVIDIA TEGRA X1 PROCESSOR + XILINX ULTRASCALE FPGA



Nexvision's CAMMASTER smart camera is a complete movie camera reference design

Designed for 4.8 GigaPixel/s processing capability

On-board video analytics (Nvidia Tegra X1)

Embedded Linux dedicated distribution



VP9

HIGHLIGHTS

Multiple extra high resolution independent video inputs from 2 (Full-HD) to 20 (X-HD™) megapixels H265-HEVC codec : 4K 30fps

On-board dedicated video enhancement image pipe (HDR, FPN, Noise reduction, EDoF), Nexvision's IP: PIXIP™ GigaEthernet, USB2.0, USB3.0, SATA, CoaxPress, 6G-SDI, Audio, HDMI video output, PCIe, SPI, I2C, RS232, NVMe, HMC Video analysis framework (third party accessible)

Onboard video recording and meta data storage: SSD NVMe (U.2), SD, SSD SATA (M.2)

Onboard streaming server based on our NexStream™





NVIDIA. TEGRA X1



ARM L











FEATURES

Extra high resolution from 2 megapixels (Full-HD) to 20 megapixels (X-HD™)

Full framerate, high quality video encoding

On-board high-end FPGA with three DDR4 SDRAM banks, dedicated to video enhancement and advanced video processing (NexVision's IP: « PIXIP »)

 $2\times300\ megapixels/s\ MSOC's\ video\ processing\ pipeline,\ two\ dedicated\ LPDDR4-SDRAM\ bank\ Codec\ (Tegra\ X1)$

H265-HEVC for minimal storage size and bandwidth: 600M pixel/s – Full HD 1080P (2 M pixels @ 60fps)

 $Optional\ video\ codec: Motion-JPEG,\ MPEG4-part2,\ RGB444\ ,\ YUV422,\ RAW,\ Cinema\ DNG,\ VP9$

Image pre-processing (FPGA)

Media processor image processing pipe

Advanced 12-bit based color processing for high fidelity color reproduction (3D LUT)

Temporal noise filtering and contrast enhancement

Multiple exposure blending provides realtime HDR for high details retention in low and over exposed area

Super resolution Multisensor capable

Multispectral band image sensor fusion (Visible, Short Wave IR, Thermal IR)

Multisensor panoramic or 360° immersive video realtime on board unwarp

Audio/Video Streaming

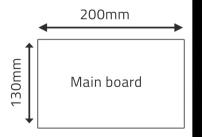
Live video streaming

Low latency path for real time viewfinder

Full Duplex Audio

Open onboard video analysis, for example: Video analysis framework, third party accessible, with 100% dedicated GPU

PHYSICAL DIMENSION



MORE DETAILS





SYSTEM

MSOC: NVIDIA TEGRA X1 media processor

High multimedia computing power (256 GPU Cores, A53/A57 64 bit multi-core ARM CPU)

NAND FLASH: 512MBytes (up to 16GB)

Tegra X1 LPDDR4-SDRAM (up to 4GB)

FPGA: NexVision's IP video pre-processor front-end with 3 x 512MB dedicated DDR4-SDRAM banks Integrated hardware watchdog

Backed up Real Time Clock



H.265

IMAGE SENSOR BOARD COMPATIBILITY

Video interface is compatible with any sensor :

Progressive scan, color with 2, 5, 8, 11, 12, 17 or 20 megapixels (X-HD™)

High sensitivity up to 12V/Lux-sec, low read noise <2e-

Selectable video resolution and frame rate by image sensor daughter boards choise Up to 16 sensor boards. any combinations of Nexvision's board.



DVIDIA

DVIDIA.

SOFTWARE DEVELOPMENT

Embedded Linux own distribution based on Linux 3.10. U-boot bootloader Nexvision's multimedia framework Multiple path video processing pipeline for simultaneous :

- > Multiple resolution
- > Multiple compression codec
- > Third party accessible video analysis and painting

Embedded NVR (Network Video Recorder) concurrent recording & streaming:

- > RTP/RTSP/RTCP Video Streaming onboard server is standard compliant
- > It also support real time bandwidth adjustment (from 40K up to 25Mbit/s),
- > Video stream encryption (128 bits AES) when used with NexStream™ technologies
- > HTTP server (only for Motion JPEG streaming) XILINX.
 - > DSP Integration with TI codec engine framework



REMOTE MANAGEMENT

Compatible with any H265, H264, VP9 RTP/RTSP compliant client like VLC, NexRMC*

Compatible with any MIPEG HTTP compliant client like VLC, NexRMC*

NexRMC is our Remote Media Center software, from our video management system NexVMS

*NexRMC is our top edge software supporting CAMMASTER's advanced features like X-HD™ resolution, sensors monitoring, firewall pass-through, innovative search in recorded video content, intuitive and user configurable interface Web-based management configuration and viewer.



NETWORK

Gigabit Ethernet 10BaseT/100Base/1000base TX - RJ-45 connector

Wireless: WIFI (802.11ac/n/g)

Optional via USB 2.0 port : Zigbee™ for remote control / Bluetooth / 4G LTE



USB 3.0

6G-SDI

STORAGE

4 x Iane PCIe Gen3 (FPGA): SSD (NVMe) - SFF-8639 expansion connector (U.2) SATA link (Tegra X1): SSD M.2 (USB compliant Storage: Flash Disk on USB Key (USB2.0)) EEPROM 128Kbits (FPGA) / EEPROM 128Kbits (Tegra X1)



SERIAL LINKS

UART (RX/TX) + I2C + SPI or GPIO - Expansion connector UART (RX/TX/CTS/RTS) or I2C or 4 x GPIO - Board to Cable connection RS232/JTAG for system debug on board connector (Jack 3.5mm for FTDI cable /20 pins)

VIDEO INPUT/OUTPUT

RAW video interface on FPGA - 74 x LVDS Pairs - 320 pins connector GENLOCK IN or OUT + Composite video output - MCX connector

1 x 3G-SDI IN or OUT by software - MCX connector

2 x CoaXPress CXP6 IN + 1 x CoaXPress CXP6 OUT by hardware assembly

> MCX connector (Power over Coax output with 12W@24V)

Linear Time Code (LTC) IN and OUT - Lemo5 connector

LCD display (with OpenGL) - HDMI 2 (with audio) - HDMI 19 pins connector D1 PAL/NTSC composite analog output from FPGA - MCX connector

3 x 6G-SDI OUT (can be used as SD, HD, or 3G-SDI) - MCX connector

1 x 3G-SDI (IN/OUT)

ENVIRONMENT SENSORS & ACTUATOR

Inertial sensors (3D accelerometer, 3D Gyroscope, 3D Magnetometer) on IO board

Pressure sensor on IO board

Temperature sensors on Main & IO board

GPS with integrated antenna

2 x piezo actuators (+100V) - Board to Cable connection on IO board

GENERAL PURPOSE I/O

MIPI-DSI LCD display + Backlight controler on IO board

General purpose IO: Buttons + LED indicators + scroll wheel (I2C extender on IO board)

8 x general purpose button – 6 x display menu selection button – 1 x power ON/OFF button

USB & PCIe

1 x USB3.0 Device (5Gb/s) for high speed video output – Micro AB connector

1 x USB2.0 Host or Device high speed (up to 480Mb/s) - Micro AB connector 5V@0.5A protected power outputs

1 x PCle 4 x lanes - SFF- 8639 connector on extension board for NVME 500 connections

1 x USB2.0 - Type A USB connector on IO board typically for 4G-LTE link.

AUDIO

Digital I/O: I2S link on TEGRA X1 & FPGA - Expansion connector

Digital Output: HDMI connector

Analog Output: Stereo headphone amplified – Jack 3.5mm IO board

Analog Inputs: Stereo balanced + switchable phantom 48V - Lemo5 connector IO board

POWER SUPPLY

Input: 10-33VDC,15W-50W - 3.96mm terminal block connector

Power voltage level and reset supervision

Super Cap or Battery charger (LiPo or Li-Ion – 6 cell) – Terminal block connector Transient voltage suppressor and EMI common mode filters with resettable fuse

Output: 2 x 12v@5A buck mode – Lemo2 connector on IO board

2 x 24v@5A buck/boost mode + remote start (RS) - Fisher3 connector on IO board

PHYSICAL DIMENSION - ENVIRONMENT

Main board: 200mm (L) x 130mm (I) x 40 (h)

Temperature: 0 to +50 °C (-40 °C to +85 °C optional)

Humidity: 10~90% non condensing



